

In development
The model is not yet in series production, but will be introduced shortly.

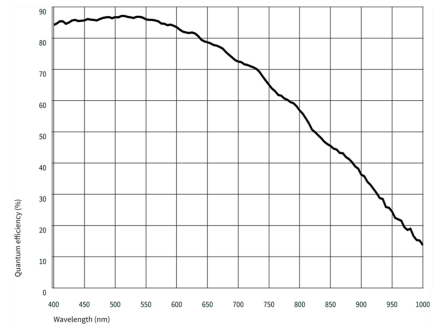


Specification

- PRELIMINARY -

Sensor

Sensor type	CMOS Mono
Shutter	Rolling shutter
Sensor characteristic	Linear
Pixel Class	2 MP
Resolution	2.12 Mpix
Resolution (h x v)	1936 x 1096 Pixel
Aspect ratio	16:9
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/2.8"
Optical Size	5.614 mm x 3.178 mm
Optical sensor diagonal	6.45 mm 1/2.8"
Pixel size	2.9 µm
CRA (Chief Ray Angle)	0 °
Manufacturer	Sony
Sensor Model	IMX662-AAMR-C
Gain (master/RGB)	31.6x/-
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	256 / 2
AOI image height / step width	1 / 1
AOI position grid (horizontal/vertical)	2 / 1
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	
Binning factor	2x2
Decimation (subsampling) horizontal	-
Decimation (subsampling) vertical	-
Decimation (subsampling) method	M/C automatic
Decimation (subsampling) factor	-



Model

Frame rate freerun mode	59 fps
Frame rate trigger (maximum)	-
Exposure time (minimum - maximum)	0.013 ms - 1999 ms
Long exposure (maximum)	120036 ms
Power consumption	2.3 W - 4.7 W
Image memory	128 MB

Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.

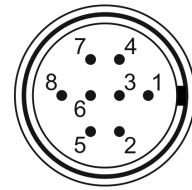
Allowed device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Allowed ambient temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	GigE RJ45, screwable
I/O connector	8-pin Hirose connector (HR25-7TR-8PA(73))
Power supply	12 V - 24 V or PoE

Pin assignment I/O connector

1	Ground (GND)
2	Flash output with optocoupler (-) - Line 1
3	General Purpose I/O (GPIO) 1 - Line 2
4	Trigger input with optocoupler (-) - Line 0
5	Flash output with optocoupler (+) - Line 1
6	General Purpose I/O (GPIO) 2 - Line 3
7	Trigger input with optocoupler (+) - Line 0
8	Input power supply (VCC) 12-24 V DC



Design

Lens Mount	C-Mount
IP code	IP30
Dimensions H/W/L	29.0 mm x 29.0 mm x 29.0 mm
Mass	51 g
Housing material	Magnesium / stainless steel

Features

List of on-camera image pre-processing features.

All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

Image Acquisition	Freerun	✓
	Software trigger	-
	Hardware trigger	-
	Trigger controlled exposure	-
	Denoiser	✓
	Long exposure	✓
	Line scan	-
	Global start	-
Flashing	Flashing	✓
	PWM flashing	✓

Image Adjustments	Auto exposure	✓
	Auto gain	✓
	Auto whitebalance	-
	Color correction	-
	Gamma	✓
	LUT	✓
	Mirror/flip	X/Y
On-board Image Processing	Pixel formats	Mono8 Mono10 Mono10p Mono12 Mono12p
	Region of interest	✓
	Decimation (FPGA)	✓
	Decimation (Sensor)	
	Binning (FPGA)	✓
	Binning (Sensor)	2x2 Increases frame rate.
Others	IP settings	✓
	Bandwidth management	✓
	Chunks	✓
	Sequencer	-
	PTP	✓
	Firmware update	✓
	1st supported firmware version	